3×12 MATRIX LED DRIVER WITH AUTO BREATH

FEATURES

- 3 current switches, 12 current sinks, up to 36 LEDs or 12 RGBs
- Programmable matrix size
- 3 pattern controllers for auto breathing or group dimming control
- 16-level global current, 3.33mA~160mA
- Individual 64-level DIM currents
- Individual 256-level FADE currents
- Individual on/off control
- 400kHz I²C interface, 4 selectable addresses (I²C Address = 0x3A/0x3B/0x38/0x39)
- Fast display refreshing with multiple parameters updating simultaneously
- Multiple-device clock synchronization by CLKIO pin
- UVLO and Over-Temperature protection
- INTN interrupt output, low active
- QFN4X4-32L package
- Power supply: VDD/VBAT(2.4~5.5V)

APPLICATIONS

- Smart speaker, Bluetooth speaker
- Gaming device (Keyboard, Mouse etc.)
- Mobile phone, PAD

TYPICAL APPLICATION CIRCUIT

GENERAL DESCRIPTION

The AW20036 is a 3×12 matrix LED driver programmed via an I²C compatible interface. The brightness of each LED is independently controlled by FADE and DIM parameter.

Three integrated pattern controllers provide auto breathing or group dimming control. Each pattern controller can work in auto breathing or manual control mode. All breathing parameters including rising/falling slope, on/off time, repeat times, min/max brightness and so on are configurable. Each LED's FADE parameter can sourced from any one of the 3 pattern controllers optionally.

Fast display refreshing is supported, multiple parameters(DIM, FADE and PAT) for each LED can be configured together through one I²C write without changing internal page register.

400kHz I²C interface is provided with 4 selectable addresses by AD pin. Multiple devices clock synchronization can be implemented by configuring the function of pin CLKIO.

AW20036 is available in QFN4X4-32L package.

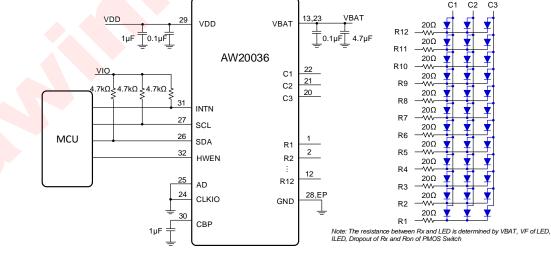


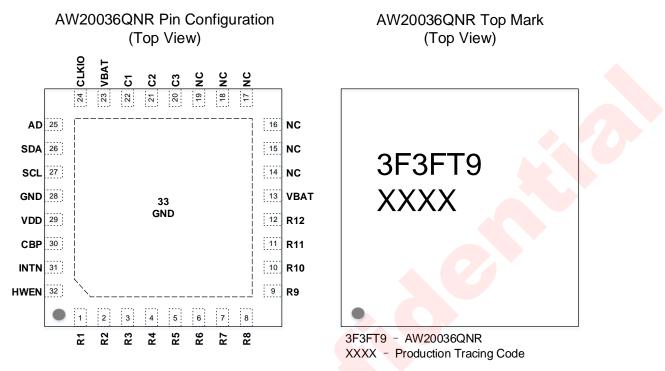
Figure 1 AW20036 Typical Application Circuit

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PIN CONFIGURATION AND TOP MARK

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No. NAME DESCRIPTION 1~12 R1~R12 Constant current sink, connect to LED's cathode VBAT 13,23 Power supply 14~19 NC No connect, must be floating 20~22 C3~C1 Current switch, connect to LED's anode in matrix display mode Synchronize pin, used to synchronize clock in multiple devices **CLKIO** 24 application, internally pulled down to GND with a resistor of $1M\Omega$ I²C address select, connects to GND, VDD, SCL or SDA for different device address of I²C. internally pulled down to GND with a resistor of 25 AD $1M\Omega$ 26 SDA Serial clock input for I²C interface 27 SCL Serial data I/O for I²C interface 28 GND Ground VDD 29 Power supply LDO output, must be connected to a at least 1µF bypass capacitor to 30 CBP GND 31 INTN Interrupt output, open drain output, low active Hardware enable control, high active, internally pulled down to GND 32 HWEN with a resistor of $1M\Omega$

PIN DEFINITION

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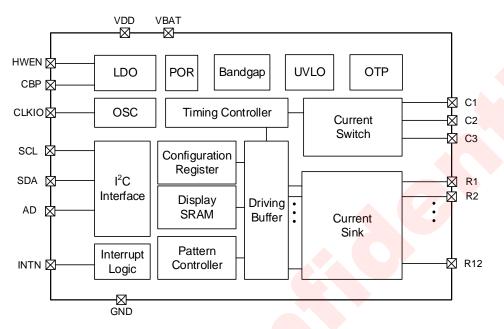
AW20036

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No.	NAME	DESCRIPTION
33	GND	Ground

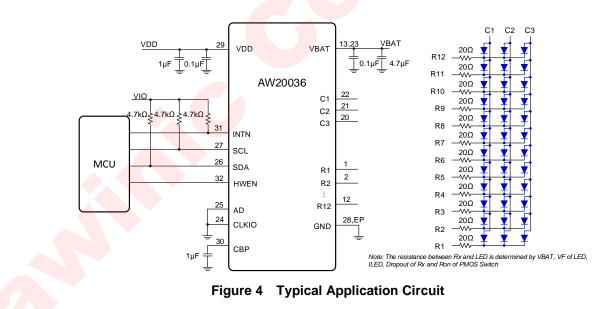
FUNCTIONAL BLOCK DIAGRAM

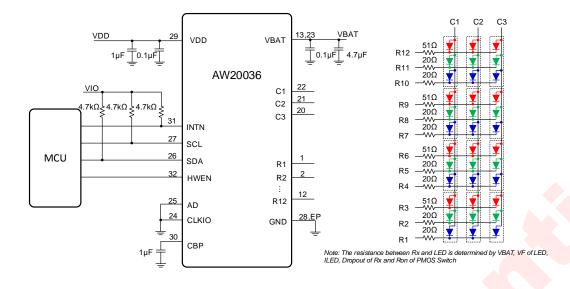
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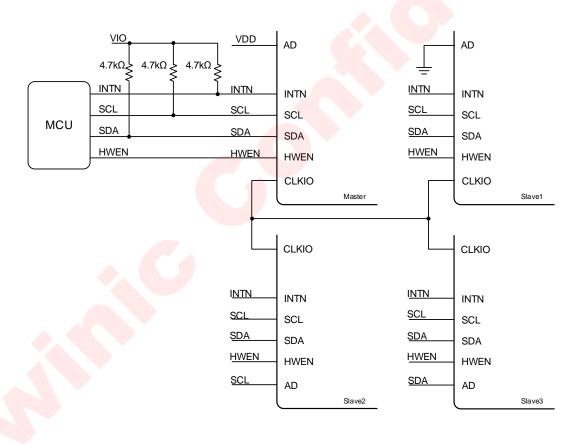


TYPICAL APPLICATION CIRCUIT











ORDERING INFORMATION

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Part Number	Temperature	Package	Marking	MSL Level	ROHS	Delivery Form
AW20036QNR	-40°C~85°C	QFN 4X4-32L	3F3FT9	MSL3	ROHS+HF	6000 units/ Tape and Re <mark>el</mark>
		AW20036		Shipping R: Tape & R Package Ty QN: QFN	Reel /pe	

ABSOLUTE MAXIMUM RATINGS(NOTE1)

BSOLUTE MAXIMUM RATINGS(NOTE1)	
PARAMETERS	RANGE
Supply Voltage Range VDD	-0.3V to 5.5V
Supply Voltage Range VBAT	-0.3V to 5.5V
Voltage on CBP	-0.3V to 2V
Voltage on SCL, SDA, AD, HWEN, INTN, CLKIO	-0.3V to V _{DD}
Maximum Power Consumption (PDmax,package@ TA=25°C)	3.84W
Junction-to-ambient Thermal Resistance θ _{JA}	30°C/W
Maximum Junction Temperature TJMAX	160°C
Storage Temperature Tstg	-65°C to 150°C
Lead Temperature (Soldering 10 Seconds)	260°C
ESD ^(NOTE 2)	•
HBM (hu <mark>man bo</mark> dy model)	±2000V
CDM	±1500V
Latch-Up	
Test Condition: JESD78D	+IT:+200mA
	-IT:-200mA

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. Test method: ESDA/JEDEC JS-001-2017.

ELECTRICAL CHARACTERISTICS

T_A=25°C, V_DD=2.8V, V_BAT=4.2V (unless otherwise noted)

	PARAMETER	TEST CONDITION	MIN	ТҮР	MAX	UNIT
Power suppl	y voltage and current					
V _{DD}	Power supply voltage		2.4		5.5	V
Vbat	Power supply voltage		2.4		5.5	V
I _{SD_VBAT}	Shutdown current of VBAT	HWEN=GND		0.1	1	μA
ISD_VDD	Shutdown current of VDD	HWEN=GND		0.1	1	μA
SB_VBAT	Standby current of VBAT	HWEN=VDD	9	18	27	μA
SB_VDD	Standby current of VDD	HWEN=VDD	25	50	75	μA
Іаст_уват	Quiescent current in	VBAT= 4.2V, HWEN=VDD, SLPCR.SLEEP = 0, display off	15	25	35	μA
Iact_vdd	active mode	VDD = 2.8V, HWEN=VDD, SLPCR.SLEEP = 0, display off	150	225	300	μA
LED Driver						
MAX-10mA	Max current of each current sink(R1~R12)	IMAX[3:0]=0000	9	10	11	mA
IMAX-40mA	Max current of each current sink(R1~R1 <mark>2)</mark>	IMAX[3:0]=0011	37.2	40	42.8	mA
MAX-160mA	Max current of each current sink(R1~R12)	IMAX[3:0]=0111	148.8	160	171.2	mA
	Match accuracy	ILED=10mA	-10%		10%	
Іматсн	IMATCH=(IRX-ILEDAVG ^(Note1))/	ILED=40mA	-6%		6%	
	ILEDAVGX100%	ILED=160mA	-5%		5%	
ILED	Average current on each LED	IMAX[3:0]=0011, FADEn = 0xFF, DIMn = 0xFF, SIZE.SWSEL = 2	11.8	13.1	14.5	mA
		ILED=40mA	50	100	200	mV
VDROPOUT	Dropout voltage for Rx	ILED=160mA	90	180	360	mV
PMOS Switc	h	L				
R _{ON}	PMOS on-resistance for Cx			0.6	1	Ω
OSC		•				
Fosc	OSC clock frequency		3.8	4.0	4.2	MHz
CLKIO, AD, H	HWEN	1		.1	I	

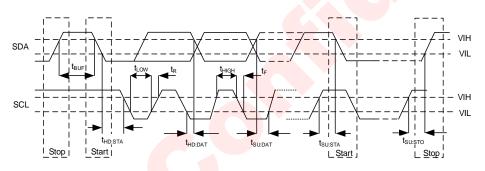
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	PARAMETER	TEST CONDITION	MIN	ТҮР	MAX	UNIT
V _{OH}	Output high level	CLKIO, I _{OH} = -2mA	V _{DD} -0.2			V
V _{OL}	Output low level	CLKIO, I _{OL} = 7.5mA			0.2	V
Vін	Input high level	CLKIO, AD, HWEN	1.3			V
VIL	Input low level	CLKIO, AD, HWEN			0.4	V
Rpd	Pull down resistance	CLKIO, AD, HWEN		1M		Ω
ΙΝΤΝ						
Vol	Output low level	I _{OL} = 10 mA			0.1	V
I ² C Interface						
Vol	Output low level	SDA,IoL = 10 mA			0.1	V
Vін	Input high level	SCL,SDA	1.3			V
VIL	Input low level	SCL,SDA			0.4	V
t _{deg_sda}	Deglitch time	SDA		200		ns
t _{DEG_SCL}	Deglitch time	SCL		150		ns

Note1: I_{RX} is the sink current of R1~R12, $I_{LEDAVG} = (I_{R1} + I_{R2} + ... + I_{R12})/12$

I²C INTERFACE TIMING

	PARAMETER	MIN	ТҮР	МАХ	UNIT
Fscl	Interface Clock frequency	-		400	kHz
THD:STA	(Repeat-start) Start condition hold time	0.6		-	μS
TLOW	Low level width of SCL	1.3		-	μS
Тнідн	High level width of SCL	0.6		-	μS
T _{SU:STA}	(Repeat-start) Start condition setup time	0.6		-	μS
T _{HD:DAT}	Data hold time	0		-	μS
T _{SU:DAT}	Data setup time	0.1		-	μS
T _R	Rising time of SDA and SCL	-		0.3	μs
T _F	Falling time of SDA and SCL	-		0.3	μS
T _{SU:STO}	Stop condition setup time	0.6		-	μS
TBUF	Time between start and stop condition	1.3		-	μS





DETAILED FUNCTIONAL DESCRIPTION

Power On Reset

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When the supply voltage VDD drops below a predefined voltage V_{POR} (1.25V), the device enters shutdown mode, and generate a reset signal to perform a power-on reset operation, which will reset all control circuits and configuration registers.

Power On Procedure

After HWEN pin set high the chip begins to load the OTP information, which takes 200us to complete. When bit SLEEP is set to "0", about 200us wait time is needed for internal oscillator startup and display SRAM initialization. After display SRAM initialization, the registers in page1 to page5 can be configured via I²C interface. Below is the recommended power on timing:

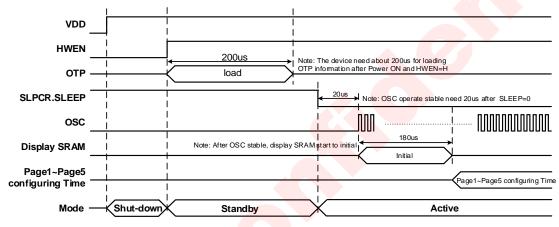


Figure 8 AW20036 power on Timing

Operating Mode

There are three operating modes in the device: Shut-down, Stand-by and Active mode.

Shut-down Mode

The device is in the shut-down mode when HWEN level is low. In shut-down mode, all internal circuits and configuration registers are reset, and the current consumption is very low (<1µA).

Standby Mode

The device enters into standby mode after pulling pin HWEN to high in shut-down mode or writing 0x80 to register SLPCR (page0,address = 0x01) via I²C interface in active mode. In standby mode, only part of internal circuit work, the OSC still keep switched off and no internal clock is available, the LDO operates in low power state.

In standby mode, the I²C interface is accessible, but only registers in page0 can be configured, page1~ page 5 is inaccessible.

Active Mode

When 0x00 is written into register SLPCR via I²C interface in standby mode, the device enters into the active mode.

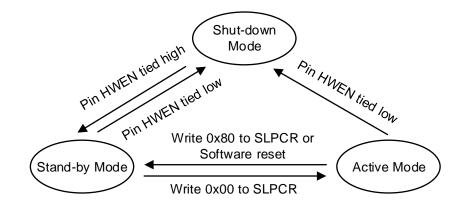


Figure 9 AW20036 Operating Mode Transition

Software Reset

Writing 0x01 to register RSTR (page0, address=0x02) via I²C interface will reset all internal circuits and configuration registers.

I²C Interface

The device supports the I²C serial bus and data transmission protocol. It operates as a slave on the I²C bus. The maximum clock frequency specified by the I²C standard is 400kHz. Connect to the bus are made via the open-drain I/O pins SCL and SDA. The pull-up resistor can be selected in the range of 1k~10k Ω and the typical value is 4.7k Ω when I²C frequency is 400kHz. Different high level from 1.8V to 3.3V of this I²C interface is supported.

Device Address

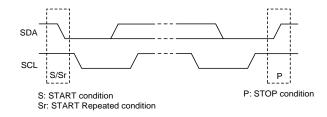
The I²C device address is 7-bit (A7~A1), followed by the R/W bit, A0 (Read=1/Write=0). Set A0 to "0" for a write command and set A0 to "1" for a read command. The values of A1 and A2 are depended on the connection of pin AD, there are 4 options: VDD, GND, SCL and SDA. The A7 to A3 is "01110" constantly. The complete slave address is:

AD pin	A7:A3	A2:A1	A0	Device address
VDD		11		3BH
GND	01110	10	0/1	3AH
SCL	01110	00	0/1	38H
SDA		01		39H

PC Start/Stop

I²C start: SDA changes form high level to low level when SCL is high level.

I²C stop: SDA changes form low level to high level when SCL is high level.

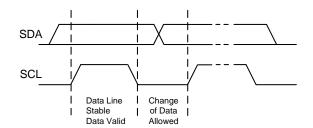




Data Validation

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When SCL is high level, SDA level must be constant. SDA can be changed only when SCL is low level.

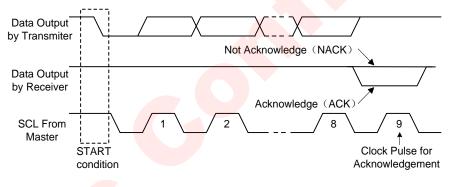


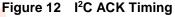


ACK (Acknowledgement)

ACK means the successful transfer of I²C bus data. After master sends an 8-bit data, SDA must be released; SDA is pulled to GND by slave device when slave acknowledges.

When master reads, slave device sends 8-bit data, releases the SDA and waits for ACK from master. If ACK is send and I²C stop is not send by master, slave device sends the next data. If ACK is not send by master, slave device stops to send data and waits for I²C stop.





Write Cycle

One data bit is transferred during each clock pulse. Data is sampled during the high state of the serial clock (SCL). Consequently, throughout the clock's high period, the data should remain stable. Any changes on the SDA line during the high state of the SCL and in the middle of a transaction, aborts the current transaction. New data should be sent during the low SCL state. This protocol allows a single data line to transfer both command/control information and data using the synchronous serial clock.

Each data transaction is composed of a start condition, a number of byte transfers (set by the software) and a stop condition to terminate the transaction. Every byte written to the SDA bus must be 8 bits long and is transferred with the most significant bit first. After each byte, an Acknowledge signal must follow.

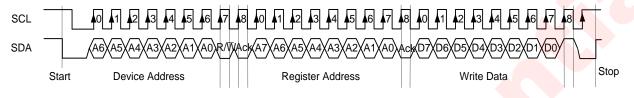
In a write process, the following steps should be followed:

- a) Master device generates START condition. The "START" signal is generated by lowering the SDA signal while the SCL signal is high.
- b) Master device sends slave address (7-bit) and the data direction bit (R/W = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.

- d) Master sends control register address (8-bit)
- e) Slave sends acknowledge signal

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- f) Master sends data byte to be written to the addressed register
- g) Slave sends acknowledge signal
- h) If master will send further data bytes the control register address will be incremented by one after acknowledge signal (repeat step f and g)
- i) Master generates STOP condition to indicate write cycle end





Read Cycle

In a read cycle, the following steps should be followed:

- a) Master device generates START condition
- b) Master device sends slave address (7-bit) and the data direction bit (R/W = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit)
- e) Slave sends acknowledge signal
- f) Master generates STOP condition followed with START condition or REPEAT START condition
- g) Master device sends slave address (7-bit) and the data direction bit (R/W = 1).
- h) Slave device sends acknowledge signal if the slave address is correct.
- i) Slave sends data byte from addressed register.
- j) If the master device sends acknowledge signal, the slave device will increase the control register address by one, then send the next data from the new addressed register.
- k) If the master device generates STOP condition, the read cycle is ended.

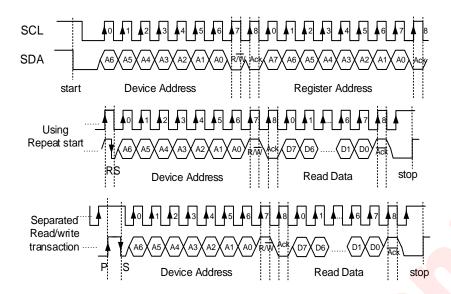


Figure 14 I²C Read Byte Cycle

Under Voltage Lock Out (UVLO)

When bit UVLOE in register FLTCFG1(page0, address=0x09) is set to "1", the device monitors the voltage on pin VDD.If voltage of VDD is detected below predefined threshold (2.0v typically) by bits UVTH[1:0] in register FLTCFG2(page0,address=0x0A), the UVLO flag bit, UVLOIS in register ISRFLT(page0,address=0x0B) is set to "1". The status will not be cleared until an I²C read on register ISRFLT.

If bit UVLOPE in register FLTCFG1 is set to "1", UVLO protection function is enabled. Once UVLO condition is met, the device will stop LED driving, set bit SLEEP in register SLPCR (page0,address=0x01) to "1", and return to stand-by state at once. If voltage on pin VDD rises above the UVLO threshold and SLEEP bit of register SLPCR is set to "0", the device will enter into active mode again.

By default, control bits UVLOE, UVLOPE are all "0". Both UVLO monitor and protection are disabled.

Bit UVIE of register FLTCFG1 is the interrupt enable bit for UVLO. If UVLOIS is "1" and bit UVIE is "1", an interrupt request will be triggered by pulling pin INTN down to low.

Over Temperature Protection (OTP)

When bit OTE in register FLTCFG1(page0,address=0x09) is set to "1", the over-temperature detection is enabled. If the temperature of this device is detected over 140°C, the over-temperature condition is triggered, and the OTPIS flag bit in register ISRFLT(page0,address=0x0B) is set to "1". The status of OTPIS=1 will be keep until an I²C read on the register ISRFLT.

If bit OTPE in register FLTCFG1 is set to "1", the Over-Temperature Protection (OTP) function is enable. When over-temperature condition is met, the device will stop LED driving, set the SLEEP bit of register SLPCR, and return to stand-by mode automatically at once. Once the temperature of the device drops below

120°C, and bit SLEEP of register SLPCR is set to "0", the device will return to active mode again.

By default, control bits OTE and OTPE are all "0", both over-temperature monitor and OTP protection are disabled.

Bit OTIE of register FLTCFG1 is the interrupt enable bit for OTP. If OTIS is "1" and bit OTIE is "1", interrupt request will be triggered by pulling pin INTN down to low.

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LED Display and Control

Matrix Scan Display Mode

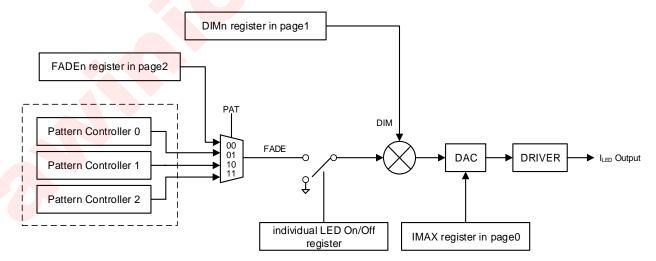
The device supports up to 36 LEDs in scan display mode, R1~R12 are constant current sinks, C1~C3 are current switches. When the device is in active mode, the device will automatically scan each column of the device in sequence from C1 to C3. The scanning frequency is about 555Hz. The scan waveform is shown below.

C1		600.5us	∙i I Hi-Z	
C2	→	4 8.5us		Hi-Z
C3	Hi-Z	0.503	¦	
R1	ООН	ОСН	18H	оон
R2	01H	ODH	19H	€ 01H
R3	(02H)	0EH	1AH	02H
R4	ОЗН	0FH		ОЗН
R5	(04H)	10H	1СН	04H
R6	(05H)	11H		05H
R7	(06H)	12H	1EH	06Н
R8	07H	(<u>13H</u>	1FH	07H
R9	08H	14H	20H	08H
R10	Оэн	15H	21H	оэн Х
R11	ОАН	<u>16H</u>	22H	ОАН
R12	ОВН	17H	23H	ОВН

Figure 15 Scan Drive Operation of AW20036

Individual LED Current Control

Each LED's brightness can be independently configured. The figure below shows the LED current control of AW20036. The brightness level of each LED is determined by value of I_{MAX}, DIM, FADE and DUTY.





The output current of each LED is calculated by the following formula:

$$I_{LED} = \begin{cases} I_{MAX} \times \frac{DIM}{63} \times \frac{FADE + 1}{256} \times DUTY & (FADE \neq 0) \\ 0 & (FADE = 0) \end{cases}$$

I_{MAX} is the global current for all LEDs, which is configured from 3.3mA to 160mA by bits IMAX[3:0] in register GCCR(page0, address=0x03). DIM is the individual DC current which is configured by register DIMn (page1, address=0x00~0x23, n=0~35). FADE is the individual scaling control of DC current, configured by register FADEm (page2, address = 0x00~0x23, m=0~35) or sourced from specified pattern controller via setting of register PATn (page3, address=0x00~0x23, n=0~35). DUTY is duty ratio of display scan, which is related to the number of active current switch, configured by bits SWSEL[3:0] in register SIZE (page0, address=0x80). The value of DUTY is determined by the following formula:

$$DUTY = \frac{592\mu s}{600.5\mu s} \times \frac{1}{SWSEL + 1}$$

Display Content Updating

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The device supports up to 36 LEDs. The location of each LED is shown by the following figure.

VBAT						
C1⊣₭ੵ C2⊣₭ੵ C3→₭ੵ						
	LED00	LED12	LED24			
	LED01	LED13	LED25			
	LED02	LED14	LED26			
	LED03	LED15	LED27			
	LED04	LED16	LED28			
	LED05	LED17	LED29			
	LED06	LED18	LED30			
	LED07	LED19	LED31			
	LED08	LED20	LED32			
R10	LED09	LED21	LED33			
	LED10	LED22	LED34			
	LED11	LED23	LED35			



In stand-by mode, only registers in page0 is configurable via I²C interface, but registers in page1 to page5 is inaccessible. After 0x00 has been written into register SLPCR and the device has been in active mode for about 200µs, page1 to page5 become accessible.

In AW20036, each LED is controlled by 4 independent parameters:

- On/Off control, bit ONx in registers LEDONx (page0, address=0x31~0x36). When bit ALLON in register GCCR (page0, address=0x03) is set, all LEDs are switched on, and registers LEDONx are ignored.
- DIM[5:0] control, register DIMn (page1, address=0x00~0x23)
- FADE[7:0] control, register FADEn (page2, address=0x00~0x23)
- PAT[1:0] selection, register PATn (page3, address= 0x00~0x23)

User can program above parameters to control each LED to be on/off directly, or control its brightness by adjusting DIM and FADE current level. Via configuring registers PATn (n=0-35), a group of LEDs can be

controlled by an internal pattern controller to dimming synchronously or output the same breathing lighting effect.

The device supports multiple parameters fast updating. The DIM, FADE and PAT parameters of each LED is distributed in page1, page2 and page3 respectively. The page4 and page5 are virtual pages. In page4, DIM and FADE parameter of each LED are put together one by one, so it is easy to update both DIM and FADE in the order of LED in very short time via one continuous write operation of I²C. Similarly, in page5, DIM,FADE and PAT parameter of each LED are put together so as to make the process of updating all display parameter very quickly. The following figure shows the distribution of display parameter in different page.

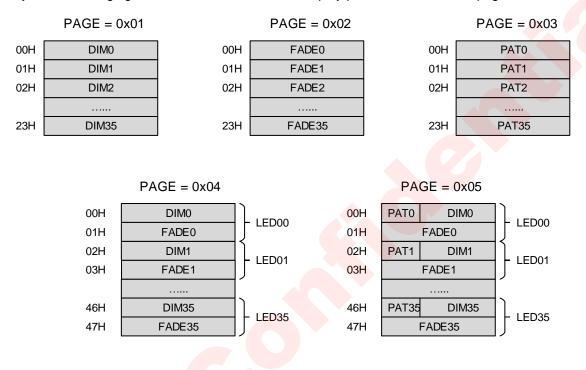


Figure 18 Display Parameter Distribution in Page1~Page5

The following flow diagram describes the general configuring process for LED display and updating.

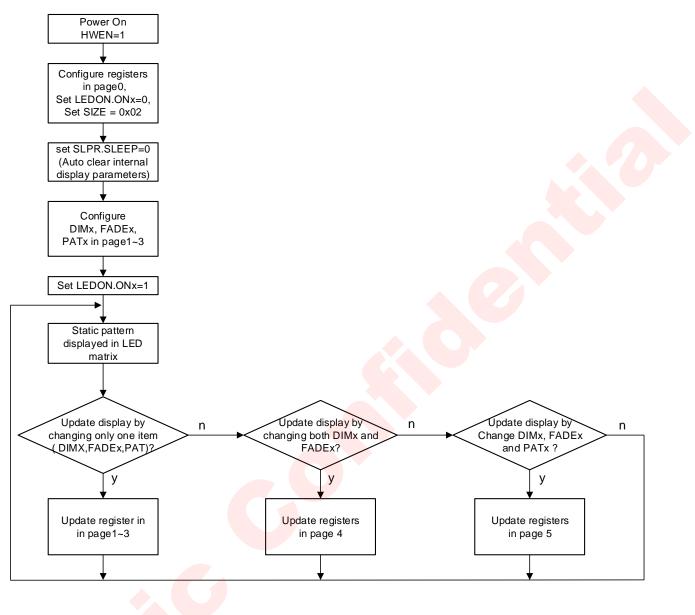


Figure 19 Configuration Process of AW20036

Pattern Controllers

There are three pattern controllers in the device. When bit PATxEN (x=0-2) in register PATCR (page0, address = 0x43) is set, corresponding pattern controller is enabled. Each pattern controller could be configured to work in autonomous breathing mode or manual-controlled mode. Individual LED can be configured by register PAT in page 3 independently to select its FADE parameter sourced from FADE register or one of the three pattern controllers.

Autonomous Breathing Mode

When bit PATMD in register PATxCFG (page0,address=0x56, 0x57, 0x58, x=0~2) is set to 1, the pattern controller works in autonomous breathing mode. In this mode, the pattern controller will generate a breathing lighting effect, which is configured by the user-defined timing parameter. The waveform of the breathing lighting effect is shown in the following figure. The parameter T1~T4 define 4 key primary time in a complete breathing period. T1~T4 composite a breathing loop, denoting the rise-time, on-time, fall-time and off- time

respectively. FADEH and FADEL are the max and min value of FADE, configurable by registers FADExH (page0,address=0x44, 0x45, 0x46, x=0~2) and FADExL(page0,address=0x47, 0x48, 0x49, x=0~2) respectively. By default, both the value of registers FADExH and FADExL are 0x00.

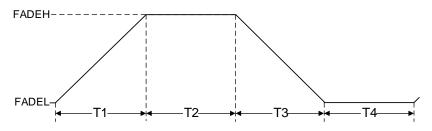


Figure 20 LED breath timing in pattern mode

The start point and end point of autonomous breathing loop configurable. The loop starting point could be selected among T1~T4, which is set by bits LB[1:0] in register PATxT2 (page0,address=0x4c, 0x50, 0x54, x=0~2). The end point of the loop can only be selected between the end of T1 and the end of T3, which is determined by bits LE[1:0] in register PATxT2. The calculation method of the loop times is determined by the end point defined. If bits LE[1:0] is not "00", the end point of breathing loop is the end of T1, and the loop counter increment by 1 at the end of T1. If bit LE[1:0] is "00", the loop end point is the end of T3, and the loop counter increment by 1 at the end of T3.

The loop times is configured by parameter LT[11:0] in register PATxT2(page0,address=0x4c, 0x50, 0x54, x=0-2) and register PATxT3 (page0,address=0x4d, 0x51, 0x55, x=0-2). When LT[11:0] are 0, the breathing loop is infinite.

After defined loop times has finished, the status bit PATxIS in register ISRFLT (page0,address=0x05, x=0~2) will be set to "1". If the corresponding interrupts enable bit PATxIE in register PATE (page0, address=0x43) is set to "1", the pin INTN will be pulled down. When the host reads register ISRFLT, the interrupt status register ISRFLT is cleared and pin INTN return to high.

Once breathing loop start again or pattern controller switches to manual mode by setting PATMD bit to "0", the PATxIS will be cleared.

When bit RUNx in register PATGO (page0, address=0x59, x=0~2) is set to 1, pattern x(x = 0~2) is started. The complete start process of the autonomous breathing machine is as follows:

- a) Set FADE, DIM parameter (FADE parameter sourced from FADE register in page2)
- b) Set corresponding LED individual on/off control register(FADE parameter sourced from FADE register in page2)
- c) Set pattern selection register PATn in page3(FADE parameter sourced from FADE register in page2)
- d) Configure PATxT0, PATxT1, PATxT2, PATxT3 for parameters T1~T4, start/stop point, and repeat times. (FADE parameter sourced from FADE register in page2)
- e) Set PATCR.PATxEN to "1"(FADE parameter sourced from pattern controller)
- f) Set PATxCFG.PATMD to "1"
- g) Set PATGO.RUNx to "1"

Manual Control Mode

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If bit PATMD in registers PATxCFG (page0, address = 0x56, 0x57, 0x58, x=0~2) is set to "0", manual mode is selected for corresponding pattern controller.

In manual control mode, user could program the bit SWITCH in register PATxCFG (page0, address =0x56,0x57,0x58, x=0-2) to control the output of pattern controller. When bit SWITCH is "1", the output of

pattern controller is the value set by register FADEHx.(page0,address=0x44, 0x45, 0x46 x= 0~2). When bit SWITCH is "0", the output of pattern controller is the value set by register FADELx (page0,address =0x47, 0x48, 0x49, x=0~2).

If bit RAMPEN in register PATxCFG is set to "1", the smooth ramp up/down will be enabled. At this time, if the bit SWITCH change from "0" to "1", the output FADE value of the pattern controller will be smoothly ramp up to FADEHx. If bit SWITCH change from "1" to "0", the output FADE of the pattern controller will ramp down smoothly to FADELx.

If the bit RAMPEN is "0", the ramp up/down function is turned off. The output FADE of the pattern controller change to FADEHx or FADELx directly based on the value of PATCFGx.SWITCH.

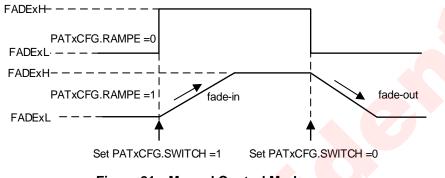


Figure 21 Manual Control Mode

Exponent Current Mode

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The device supports exponential current mode, which is enabled when the bit EXPEN in register GCCR.(page0, address= 0x03) is set to "1". In this mode, only the low 6-bit of FADEn register in page2 is valid, it will be internally converted to 8-bit exponential current.

Multiple Device Synchronization

The AW20036 supports multiple device synchronization to drive more than 36 LEDs by cascade of multiple devices. In this application, all devices share a common clock, one device works as a master to output common clock on pin CLKIO, and other devices work as slave to use external input clock from pin CLKIO.

Bit CLK_IO and CLK_SEL in register CLKSYS (page0,address=0x05) select the clock input or output on pin CLKIO

CLK_IO	CLK_SEL	Device Clock Selection
0	0	Use Internal clock and pin CLKIO is high-Z
1	0	Master, use internal clock and output it on pin CLKIO
0	1	Slave, use external clock from pin CLKIO
1	1	Forbidden

REGISTER CONFIGURATION

Register Control

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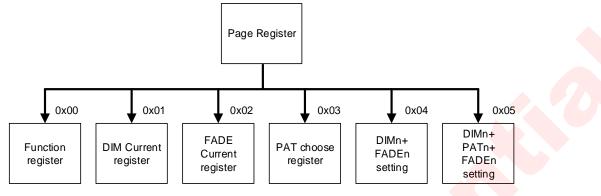


Figure 22 Register Control

Register List

Add.	Name	W/R	Function description	Default Value
Page = 0x00),0x01,0x02,0x	(03.0x04	1.0x05	value
F0H	PAGE	R/W	Page configuration	00H
-	D: Function reg			
00H	IDR	R	Chip ID	18H
01H	SLPCR	R/W	Sleep mode control	80H
02H	RSTR	W	Soft reset	00H
03H	GCCR	R/W	Global current configuration	10H
04H	FCD	W	Fast cle <mark>ar</mark> dis <mark>pla</mark> y	00H
05H	CLKSYS	R/W	Clock control	00H
09H	FLTCFG1	R/W	Fault configuration register1	00H
0AH	FLTCFG2	R/W	Fault configuration register2	00H
0BH	ISRFLT	R	Interrupt status	00H
31H	LEDON0	W	Individual LED on/off control	00H
32H	LEDON1	W	Individual LED on/off control	00H
33H	LEDON2	W	Individual LED on/off control	00H
34H	LEDON3	W	Individual LED on/off control	00H
35H	LEDON4	W	Individual LED on/off control	00H
36H	LEDON5	W	Individual LED on/off control	00H
43H	PATCR	R/W	Pattern enable control	00H
44H	FADEH0	R/W	Maximum breathing level of pattern0	00H
45H	FADEH1	R/W	Maximum breathing level of pattern1	00H
46H	FADEH2	R/W	Maximum breathing level of pattern2	00H
47H	FADEL0	R/W	Minimum breathing level of pattern0	00H
48H	FADEL1	R/W	Minimum breathing level of pattern1	00H
49H	FADEL2	R/W	Minimum breathing level of pattern2	00H
4AH	PAT0T0	R/W	T1 & T2 configuration of pattern0	00H
4BH	PAT0T1	R/W	T3 & T4 configuration of pattern0	00H
4CH	PAT0T2	R/W	Loop configuration register1 of pattern0	00H
4DH	PAT0T3	R/W	Loop configuration register2 of pattern0	00H
4EH	PAT1T0	R/W	T1 & T2 configuration of pattern1	00H
4FH	PAT1T1	R/W	T3 & T4 configuration of pattern1	00H
50H	PAT1T2	R/W	Loop configuration register1 of pattern1	00H
51H	PAT1T3	R/W	Loop configuration register2 of pattern1	00H
52H	PAT2T0	R/W	T1 & T2 configuration of pattern2	00H
53H	PAT2T1	R/W	T3 & T4 configuration of pattern2	00H
54H	PAT2T2	R/W	Loop configuration register1 of pattern2	00H

Add.	Name	W/R	Function description	Default Value
55H	PAT2T3	R/W	Loop configuration register2 of pattern2	00H
56H	PAT0CFG	R/W	Mode configuration of pattern0	00H
57H	PAT1CFG	R/W	5	
58H	PAT2CFG	R/W	Mode configuration of pattern2	00H
59H	PATGO	R/W	Start pattern 0/1/2	00H
80H	SIZE	R/W	Display size configuration	08H
Page=0x01:	DIM current s	etting		
00H~23H	DIMn	W	DIM current configuration	00H
Page=0x02:	FADE current	setting		
00H~23H	FADEn	W	FADE current configuration	00H
Page=0x03:	PAT selection	setting		
00H~23H	PATn	W	Pattern selection	00H
Page=0x04:	DIM and FAD	E setting	g · · · · · · · · · · · · · · · · · · ·	
00H~47H	DIMn+ FADEn	W	DIM and FADE configuration of each LED	00H
Page=0x05: DIM, PAT and FADE setting		FADE	setting	
00H~47H	PATn/DIMn +FADEn	W	PAT, DIM and FADE configuration of each LED	00H

Register Bit Map

PAGE = 0x00,0x01,0x02,0x03,0x04,0x05

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
F0H	PAGE	R/W	-	-	-		-		PAGE	

PAGE = 0x00

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	
00H	IDR	R				l	D				
01H	SLPCR	R/W	SLEEP	-	-	-	-	-	-	-	
02H	RSTR	R/W		SW				RSTN			
03H	GCCR	R/W			MAX		ALLON	-	-	EXPEN	
04H	FCS	W	-	-	-	-	-	-	-	FCDE	
05H	CLKSYS	R/W	-	-	-	-	-	-	CLK_IO	CLK_SEL	
09H	FLTCFG1	R/W	-	-	UVLOPE	OTPE	UVIE	OTIE	UVLOE	OTE	
0AH	FLTCFG2	R/W	-	-	-	-	UV	TH	-	-	
0BH	ISRFLT	R	-	PAT2IS	PAT1IS	PAT0IS	-	-	UVLOIS	OTIS	
31H	LEDON0	W	-	-	ON5	ON4	ON3	ON2	ON1	ON0	
32H	LEDON1	W	-	-	ON11	ON10	ON9	ON8	ON7	ON6	
33H	LEDON2	V	-	-	ON17	ON16	ON15	ON14	ON13	ON12	
34H	LEDON3	W	-	-	ON23	ON22	ON21	ON20	ON19	ON18	
35H	LEDON4	W	-	-	ON29	ON28	ON27	ON26	ON25	ON24	
36H	LEDON5	W	-	-	ON35	ON34	ON33	ON32	ON31	ON30	
43H	PATCR	R/W	-	PAT2IE	PAT1IE	PAT0IE	-	PAT2EN	PAT1EN	PAT0EN	
44H	FADEH0	R/W					EH0				
45H	FADEH1	R/W				FAD	EH1				
46H	FADEH2	R/W				FAD	EH2				
47H	FADEL0	R/W				FAD	EL0				
48H	FADEL1	R/W				FAD)EL1				
49H	FADEL2	R/W	FADEL2								
4AH	PAT0T0	R/W	T1 T2								
4BH	PAT0T1	R/W		T3 T4							
4CH	PAT0T2	R/W	L	LE LB LT[11:8]							
4DH	PAT0T3	R/W	LT[7:0]								
4EH	PAT1T0	R/W		T1 T2							

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Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	
4FH	PAT1T1	R/W		T3				Τ4			
50H	PAT1T2	R/W	L	.E	L	В		LT[1	1:8]		
51H	PAT1T3	R/W				LT[7:0]				
52H	PAT2T0	R/W			T1			Т	2		
53H	PAT2T1	R/W			Т3			Т	4		
54H	PAT2T2	R/W	L	.E	L	В		LT[1	1:8]		
55H	PAT2T3	R/W				LT[7:0]				
56H	PAT0CFG	R/W	-	-	-	-	-	SWITCH	RAMPE	PATMD	
57H	PAT1CFG	R/W	-	-	-	-	-	SWITCH	RAMPE	PATMD	
58H	PAT2CFG	R/W	-	-	-	-	-	SWITCH	RAMPE	PATMD	
59H	PATGO	R/W	-	PAT2ST	PAT1ST	PAT0ST	-	RUN2	RUN1	RUN0	
80H	SIZE	R/W	-	-	-	-		SW	SEL		

PAGE = 0x01

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00H	DIM0	W	-	-	DIMO					
01H	DIM1	W	-	-			DIM	1		
23H	DIM35	W	-	-	DIM35					

PAGE = 0x02

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00H	FADE0	W				FAD	DE0			
01H	FADE1	W				FAD	DE1			
23H	FADE35	W	FADE35							

PAGE = 0x03

F	PAGE =	0x03									
	Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
Ī	00H	PAT0	W	-	-	-	-	-	-	PA	AT0
Ī	01H	PAT1	W	-	-	-	-	-	-	PA	\T1
Ī				-	•						
	23H	PAT35	W	-	-	-	-	-	-	PA	T35

PAGE = 0x04

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00H	DIMO	W	-	-	- DIMO					
01H	FADE0	W			FADE0					
02H	DIM1	W	-	-			DIM	1		
03H	FADE1	W		FADE1						
			-	-						
46H	DIM35	W	-	- DIM35						
47H	FADE35	W		FADE35						

PAGE = 0x05

Add.	Name	W/R	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00H	PAT/DIM0	W	PA	\ Τ0	DIMO					
01H	FADE0	W				FA	DE0			
02H	PAT/DIM1	W	PAT1 DIM1							
03H	FADE1	W				FA	DE1			
				-						

46H	PAT/DIM35	W	PAT35	DIM35		
47H	FADE35	W	FADE35			

Detailed Register Description

IDR, Chip ID Register

IDR, Chip ID Register	
PAGE: 0x00, Address: 0x00, RO, default: 0x18	
7 6 5 4 3 2 1	0
ID	
Bit Symbol Description	
7:0 ID Chip ID is 18H	
SLPCR, Sleep Control Register	
PAGE: 0x00, Address: 0x01, R/W, default: 0x80	
7 6 5 4 3 2 1	0
SLEEP -	
Bit Symbol Description	
7 SLEEP Sleep Mode Control	
0: Active mode	
1: Standby mode	
6:0 - Un-defined	
RSTR, Reset Control Register	
PAGE: 0x00, Address: 0x02, W, default: 0x00	
7 6 5 4 3 2 1	0
SW_RSTN	
Bit Symbol Description	
7:0 SW_RSTN Soft reset control. Write "0x01" to reset all configuration register an logic	nd internal
GCCR, Global Current Configuration Register	
PAGE: 0x00, Address: 0x03, R/W, default: 0x10	
7 6 5 4 3 2 1	0
IMAX ALLON	EXPEN
Bit Symbol Description	

91	vinic	上海艾为电子技术股份有 shanghai awinic technology		AW20036 Apr. 2019 V1.3
7:4	IMAX	Global Max Current (IMAX)	Setting	
		0000: 10mA	1000: 3.3mA	
		0001: 20mA	1001: 6.7mA	
		0010: 30mA	1010: 10mA	
		0011: 40mA	1011: 13.3mA	
		0100: 60mA	1100: 20mA	
		0101: 80mA	1101: 26.7mA	
		0110: 120mA	1110: 40mA	
		0111: 160mA	1111: 53.3mA	
3	ALLON	Force All LED Switch On 0: LED On/off is defined by 1: Force all LED to be on, iç		
2:1	-	Reserved. Must set to "00"		
0	EXPEN	Exponent Transform Enable	e for FADE	
		0: FADE parameter is 8-bit L	inear code	
		1: FADE parameter is 6-bit li first, and then drive output c	ed into 8-bit exponential code	

FCD, Fast Clear Display Control Register

PAGE: 0x00, Address: 0x04, W, default: 0x00										
7	6	5	4	3	2	1	0			
			FC	DE						
Bit										
7:0	FCDE	Fast clear di	splay enable,	write "0x01" to	o clear display a	at once.				

CLKS<mark>YS, Cloc</mark>k Control Register

PAC	PAGE: 0x00, Address: 0x05, R/W, default: 0x00									
	7	6	5	4	3	2	1	0		
	-	-	-	-	-	-	CLK_IO	CLK_SEL		
Bit	S	ymbol	Description							

7:2 - Un-defined. Should be set to "000000"

1	CLK_IO	Clock output control for pin CLKIO 0: Pin CLKIO does not output clock 1: Pin CLKIO output clock
0	CLK_SEL	Clock Source Selection 0: Use internal 4MHz OSC clock 1: Use clock input from pin CLKIO

FLTCFG1, Fault Configuration Register1

PAGE: 0x00, Address: 0x09, R/W, default: 0x00

PAGE. 0X	00, Address: 0x0 6	5 5	4	3	2	1	0
-	-	UVLOPE	OTPE	UVIE	OTIE	UVLOE	OTE
Bit	Symbol	Description				3	
7:6	-	non-defined					
5	UVLOPE	UVLO Prote	ction Enable				
		0: Disable U	VLO protectio	n			
		1: Enable U	VLO protection	n ,set SLPCR.	SLEEP when	ISRFLT. UVLO	DIS = 1
4	OTPE	Over-temp <mark>e</mark>	rature (OT) Pr	otection Enab	le		
		0:Disable O	r protection.				
		1: Enable O	T protection, s	set SLPCR.SLI	EEP when ISP	RFLT.OTIS = 1	
3	UVIE	UVLO Interr	upt Enable				
		0:Disable U	/LO interrupt				
		1:Enalbe UV	LO interrupt				
2	OTIE	Over Tempe	erature Interru	pt Enable			
		0:Disable O					
		1:Enalbe OT	interrupt				
9		–		. ".			
1	UVLOE		O Detection F				
			/LO detection	1			
		I:Enable UV	LO detection				
0	OTE	Enable Over	-Temperature	e Detection			

0:Disable Over-temperature detection

1:Enable Over-temperature detection

FLTCFG2, Fault Configuration Register2

PAGE: 0x00, Address: 0x0A, R/W, default: 0x00

7	6	5	4	3	2	1	0			
-	-	-	-	UV	TH	-	-			
Bit	Symbol	Description								
7:4	-	Reserved, s	hould be set a	as "0000"						
		,								
3:2	UVTH	UVLO Threshold Voltage Selection 00: 2.0v (default)								
		01: 2.1v								
		10: 2.2v								
		11: 2.3v								
1:0	-	Reserved. S	hould be set a	as "00"						

ISRFLT, Interrupt Status Register

PAGE: 0x	PAGE: 0x00, Address: 0x0B, RO, default: 0x00									
7	6	5	4	3	2	1	0			
-	PAT2IS	PAT1IS	PATOIS	-	-	UVLOIS	OTIS			
Bit	Symbol	Description	Description							
7	- Un-defined									
6:4	PATxIS	Pattern cont	ttern controller x (x = 0 ~2) Interrupt Status							
		0: No Interru	: No Interrupt							
		1: Auto Brea	th Loop Finisl	ned Interrupt F	Request					
3:2	-	Un-defined	1: Auto Breath Loop Finished Interrupt Request Un-defined							
1	UVLOIS	UVLO Detec	UVLO Detection Status							
		0: No UVLO	0: No UVLO detected							
	1: UVLO detected									

 Bit
 Symbol
 Description

 0
 OTIS
 Over-temperature Detection Status

 0: No Over-temperature detected
 1: Over-temperature detected

LEDON0~5, Individual LED On/off Control Register

PAGE: 0x00, Address: 0x31~0x36, W, default: 0x00

7	6	5	4	3	2	1	0
-	-	ON5	ON4	ON3	ON2	ON1	ON0
-	-	ON11	ON10	ON9	ON8	ON7	ON6
-	-	ON17	ON16	ON15	ON14	ON13	ON12
-	-	ON23	ON22	ON21	ON20	ON19	ON18
-	-	ON29	ON28	ON27	ON26	ON25	ON24
-	-	ON35	ON34	ON33	ON32	ON31	ON30

Bit	Symbol	Description
7:6	-	Un-defined
5:0	ONx	LEDx On/off Control
		0: LEDx off
		1: LEDx on

PATCR, Pattern Enable Control Register

PAGE: 0x00, Address: 0x43, R/W, default: 0x00

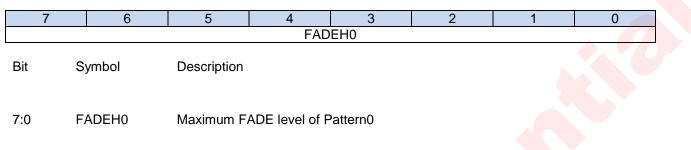
	7	6	5	4	3	2	1	0	
	-	PAT2IE	PAT1IE	PATOIE	-	PAT2EN	PAT1EN	PAT0EN	
	Bit	Symbol	Description						
7 - Un-defined									
	6:4	PATxIE	Pattern Controller x Interrupt Enable						
			0: Disable Pattern x Interrupt						
			1: Enable Pattern x Interrupt						
	3	-	Un-defined						
	2:0 PATxEN Pattern Controller x Enable								

- 0: Disable Pattern x
- 1: Enable Pattern x

FADEH0, Pattern0 Maximum Breathing Level Register

PAGE: 0x00, Address: 0x44, R/W, default: 0x00

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FADEH1, Pattern1 Maximum Breathing Level Register

PAGE: 0x00, Address: 0x45, R/W, default: 0x00

7	6	5	4	3	2	1	0		
	FADEH1								
Bit	Symbol	Description							
7:0	7:0 FADEH1 Maximum FADE level of Pattern1								

FADEH2, Pattern2 Maximum Breathing Level Register

PAGE: 0x00, Address: 0x46, R/W, default: 0x00

	7	0	F	4	0	0	4	0	
	1	6	5	4	3	Ζ	1	0	
				FAD	EH2				
Bit	Bit Symbol Description								
7:0	7:0 FADEH2 Maximum FADE level of Pattern2								

FADEL0, Pattern0 Minimum Breathing Level

PAGE: 0x00, Address: 0x47, R/W, default: 0x00

	7 6	5	4	3	2	1	0
			FAD	DELO			
Bit	Bit Symbol Description						
7:0	FADEL0	Minimum FA	DE level of P	attern0			

FADEL1, Pattern1 Minimum Breathing Level

PAGE: 0x00, Address: 0x48, R/W, default: 0x00

7	6	5	4 FADEL	3	2	1	0
it	Symbol	Description					
:0	FADEL1	Minimum F	ADE level of Patte	ern1			
ADEL:	2, Pattern2 Min	nimum Breathin	ng Level				
AGE: (0x00, Address:	0x49, R/W, defa	ault: 0x00				
7	6	5	4	3	2	1	0
			FADEL	2			
it	Symbol	Description					
:0	FADEL2	Minimum F	ADE level of Patte	ern2			
			o				
		1210, 11 & 12 (Configuration Re	gister			
AGE: 0		, R/W, default: (00x0				
):Address: 0x4E	i, R/W, default: (0x00				
):Address: 0x4E	, R/W, default: (, R/W, default: (5	0x00	3	2	1	0
AT2T0):Address: 0x4E):Address: 0x52	, R/W, default: (, R/W, default: (0x00 0x00	3		1 T2	0
AT2T0):Address: 0x4E):Address: 0x52	i, R/W, default: (, R/W, default: (5 T1	0x00 0x00 4	3			0
AT2T0 7):Address: 0x4E):Address: 0x52 6	i, R/W, default: (, R/W, default: (5 T1	0x00 0x00 4	3			0
AT2T0 7):Address: 0x4E):Address: 0x52 6	E, R/W, default: (, R/W, default: (5 T1 Description	0x00 0x00 4	3			0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	E, R/W, default: (, R/W, default: (5 T1 Description	0x00 0x00 4	3			0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	E, R/W, default: (, R/W, default: (5 T1 Description T1 (Rise-t	0x00 0x00 4 on time) Selection				0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	E, R/W, default: (, R/W, default: (5 T1 Description T1 (Rise-the 0000:	0x00 0x00 4 on time) Selection 0.00s (default)	1000:	2.1s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	E, R/W, default: 0 , R/W, default: 0 5 T1 Description T1 (Rise-the 0000: 0001:	0x00 0x00 4 on cime) Selection 0.00s (default) 0.13s	1000: 1001:	2.1s 2.6s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	E, R/W, default: 0 C, R/W, default: 0 T1 Description T1 (Rise-the 0000: 0001: 0010:	0x00 0x00 0x00 0x00 0x00 4 0 0x00	1000: 1001: 1010:	2.1s 2.6s 3.1s 4.2s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	 F, R/W, default: 0 R/W, default: 0 T1 Description T1 (Rise-the option option	0x00 0x00 0x00 4 0 0 0 0 0 0 0 0 0 0 0 0 0	1000: 1001: 1010: 1011: 1100:	2.1s 2.6s 3.1s 4.2s 5.2s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	F, R/W, default: 0 T1 Description T1 (Rise-theorem of the section of the secti	0x00 0x00 4 on time) Selection 0.00s (default) 0.13s 0.26s 0.38s 0.51s 0.77s	1000: 1001: 1010: 1011: 1100: 1101:	2.1s 2.6s 3.1s 4.2s 5.2s 6.2s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	 R/W, default: 0 R/W, default: 0 T1 Description T1 (Rise-t 0000: 0001: 0010: 0010: 0011: 0100: 0101: 0101: 0110: 	0x00 0x00 4 0 0 0 0 0 0 0 0 0 0 0 0 0	1000: 1001: 1010: 1011: 1100: 1101: 1110:	2.1s 2.6s 3.1s 4.2s 5.2s 6.2s 7.3s		
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	F, R/W, default: 0 T1 Description T1 (Rise-theorem of the section of the secti	0x00 0x00 4 on time) Selection 0.00s (default) 0.13s 0.26s 0.38s 0.51s 0.77s	1000: 1001: 1010: 1011: 1100: 1101:	2.1s 2.6s 3.1s 4.2s 5.2s 6.2s		0
AT2T0 7 Bit 7:4	0:Address: 0x4E 0:Address: 0x52 6 Symbo T1	 R/W, default: 0 R/W, default: 0 T1 Description T1 (Rise-t 0000: 0001: 0010: 0010: 0011: 0100: 0101: 0110: 0111: 	0x00 0x00 4 on time) Selection 0.00s (default) 0.13s 0.26s 0.38s 0.51s 0.77s 1.04s 1.6s	1000: 1001: 1010: 1011: 1100: 1101: 1110:	2.1s 2.6s 3.1s 4.2s 5.2s 6.2s 7.3s		0
AT2T0 7 Bit	0:Address: 0x4E 0:Address: 0x52 6 Symbo	 R/W, default: 0 R/W, default: 0 T1 Description T1 (Rise-t 0000: 0001: 0010: 0010: 0011: 0100: 0101: 0110: 0111: 	0x00 0x00 4 0 0 0 0 0 0 0 0 0 0 0 0 0	1000: 1001: 1010: 1011: 1100: 1101: 1110:	2.1s 2.6s 3.1s 4.2s 5.2s 6.2s 7.3s		0

0001:	0.13s	1001:	2.6s
0010:	0.26s	1010:	3.1s
0011:	0.38s	1011:	4.2s
0100:	0.51s	1100:	5.2s
0101:	0.77s	1101:	6.2s
0110:	1.04s	1110:	7.3s
0111:	1.6s	1111:	8.3s

PAT0T1/PAT1T1/PAT2T1, T3 & T4 Configuration Register

7	Address: 0x53, I	5	4	3	2 1	0
•		T3		J J	T4	J J
Bit	Symbol	Descriptic	on			
7:4	Т3	T3 (Fall-ti	me) Selection			
		0000:	0.00s (default)	1000:	2.1s	
		0001:	0.13s	1001:	2.6s	
		0010:	0.26s	1010:	3.1s	
		0011:	0.38s	1011:	4.2s	
		0100:	0.51s	1100:	5.2s	
		0101:	0.77s	1101:	6.2s	
		0110:	1.04s	1110:	7.3s	
		0111:	1.6s	1111:	8.3s	
3:0	Τ4	T4 (Off-tir	ne) Selection			
		0000:	0.04s (default)	1000:	2.1s	
		0001:	0.13s	1001:	2.6s	
		0010:	0.26s	1010:	3.1s	
		0011:	0.38s	1011:	4.2s	
		0100:	0.51s	1100:	5.2s	
		0101:	0.77s	1101:	6.2s	
		0110:	1.04s	1110:	7.3s	
		0111:	1.6s	1111:	8.3s	

PAT0T2/PAT1T2/PAT2T2, Loop Configuration Register1

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PAT1T2	x00 :Address: 0x4C, F :Address: 0x50, F :Address: 0x54, F	R/W, default: 0x	00				
7	6	5	4	3	2	1	0
	LE	L	3		LT[1	1:8]	
Bit	Symbol	Description					
7:6	LE	Loop End Po	oint Setting				
		00: Loop end	d at OFF state	e(End of T3)			
		Other: Loop	end at ON sta	ate(End of T1)	I		
5:4	LB	Loop Beginn 00: Loop beg 01: Loop beg 10: Loop beg 11: Loop beg	gin from T2 gin from T3	ting			
3:0	LT[11:8]	4 MSB of Lo	op Times (LT). When LT[11	1:0] are all 0, tl	ne loop is end	-less.

PAT0T3/ PAT1T3/ PAT2T3, Loop Configuration Register2

PAGE: 0x00 PAT0T3:Address: 0x4D, R/W, default: 0x00 PAT1T3:Address: 0x51, R/W, default: 0x00 PAT2T3:Address: 0x55, R/W, default: 0x00										
7 6 5	4	3	2	1	0					
	Ľ	TL								
Bit Symbol Descript	ion									
7:0 LT[7:0] 8 LSB o	i Loop Times (LT)). When LT[11	:0] are all 0, th	e loop is end-	less.					
PATOCFG/ PAT1CFG / PAT2CFG,	7:0 LT[7:0] 8 LSB of Loop Times (LT). When LT[11:0] are all 0, the loop is end-less. PATOCFG/ PAT1CFG / PAT2CFG, Pattern Mode Configuration Register									
PAGE: 0x00 PAT0CFG: Address: 0x56, R/W, def PAT1CFG: Address: 0x57, R/W, def	PAGE: 0x00 PAT0CFG: Address: 0x56, R/W, default: 0x00									

PAT2CFG: Address: 0x58, R/W, default: 0x00								
7	6	5	4	3	2	1	0	
-	-	-	-	-	SWITCH	RAMPE	PATMD	

Bit Symbol Description

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7:3	-	Undefined
2	SWITCH	Manual on/off Control 0: LED off 1: LED on
1	RAMPE	Ramp Enable. Only active in manual control mode. 0: No ramp 1: Ramp enabled
0	PATMD	Pattern Mode Selection 0: Manual control mode 1: Auto breathing Mode

PATGO, Start Pattern 0/1/2 Register

PAGE: 0x00, Address: 0x59, R/W, default: 0x00

7	6	5	4	3	2	1	0
-	PAT2ST	PAT1ST	PAT0ST	-	RUN2	RUN1	RUN0
Bit	Symbol	Description					
7	-	non-defined					
6:4	PATxST	Pattern x Ru	Inning Status				
		0: Pattern x 1: Pattern x	is not running is running				
3	-	Reserved. S	should be set a	as "0"			
2:0	RUNx	Pattern Run	Control. Write	e "1" to corres	ponding bit to	start up patter	n x

SIZE, Display Size Configuration Register

PAGE: 0x00	, Address: 0x8	0, R/W, defau	ılt: 0x08				
7	6	5	4	3	2	1	0
-	-	-	-		SW	SEL	

Bit Symbol Description

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Bit	Symbol	Description	
7:4	-	Reserved. Should be set as "0000"	
3:0	SWSEL	Current Switch Number Selection 0000: 1 current switch (C1), drive 1x12 LED 0001: 2 current switch(C1,C2), drive 2x12 LEDs 0010: 3 current switch(C1,C2,C3), drive 3x12 LEDs	
		Other: Reserved, don't use	

PAGE, Page Configuration Register

7		6	5	4	3	2	1	0
-		-	-	-	-		PAGE	
Bit	S	ymbol	Description					
7:3	-		Un-defined					
2:0	P	AGE	Page Numb	er.				
			Write 0xC0:	set current pa	i <mark>ge</mark> to page0			
			Write 0xC1:	set current pa	ige to page1			
			Write 0xC2:	set current pa	ige to page2			
			Write 0xC3:	set current pa	ige to page3			
			Write 0xC4:	set current pa	ige to page4			
			Write 0xC5:	set current pa	ige to page5			

Page1 Register

DIMn, DIM Current Configuration Register

		aa 144		~ ~ ~
Address: (0x00~0x	23, W,	default:	0x00

7	6	5	4	3	2	1	0		
	-	DIM							
Bit	Symbol	Description							
7:6	-	non-defined							
5:0	DIM	6-bit DIM pa	rameter Setti	ng of individua	I LED				

Page2 Register

FADEn, FADE Current Configuration Register

Address:	0x00~0x23,	W	default [.]	0x00
Audiess.	0100~0123,	٧٧,	uciauit.	0000

7	6	5	4	3	2	1	0		
FADE									
Bit	Symbol	Description							
7:0 FADE 8-bit FADE Parameter Setting for individual LED. When bit EXPEN of register GCCR is "1", bits FADE[7:6] are ignored, and only FADE[5:0] is valid to provide 64-level of exponential FADE current.									

Page3 Register

PATn, Pattern Selection Register

,											
Addres	s: 0x(00~0x23, W, d	lefault: 0x00								
7		6	5	4	3	2	1	0			
-		-	-	-	-		P/	AT			
Bit	S	ymbol	Description								
7:2	-		Undefined	Undefined							
1:0	P	AT	Pattern Con	trol Selection	f <mark>or i</mark> ndividual L	.ED					
			00: FADE pa	arameter com	es from FADE	n register.					
	01: FADE parameter comes from pattern controller 0.										
			10: FADE pa	arameter com	es from patter	n controller 1.					
			11: FADE pa	arameter com	es from patter	n controller 2.					

Page4 Register

DIMn, DIM Current Configuration Register

Address: 0x00~0x46,even address only, W, default: 0x00

7	6	5	4	3	2	1	0			
-	-	DIMn								
		(Refer to definition of DIMn in page1)								

FADEn, FADE Current Configuration Register

Address: 0x01~0x47,odd address only, W, default: 0x00									
7 6 5 4 3 2 1 0									
	FADEn								
(Refer to definition of FADEn in page2)									

Page5 Register

DIMn, DIM Current Configuration Register

Address: 0x00~0x46, even address only, W, default: 0x00

7	6	5	4	3	2	1	0
(Refer to c	Tn lefinition of page3)		(Refe	DII er to definition	VIn of DIMn in pa	ige1)	

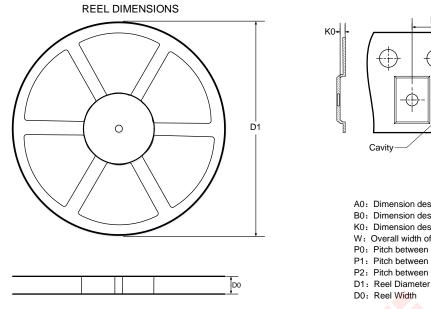
FADEn, FADE Current Configuration Register

Address: 0x0	01~0x47,odd a	address only, \	W, default: 0x0	00	
7	6	F	1	2	(

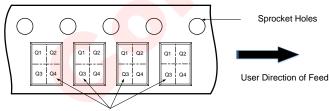
7	6	5	4	3	2	1	0		
FADEn									
(Refer to definition of FADEn in page2)									

TAPE AND REEL INFORMATION

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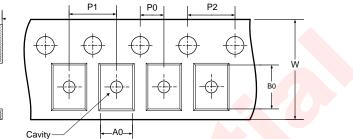
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Pocket Quadrants

All Dimensions are nominal									
D1 (mm)	D0 (mm)				P0 (mm)			W (mm)	Pin1 Quadrant
330	12.4	4.3	4.3	1.1	2	8	4	12	Q1

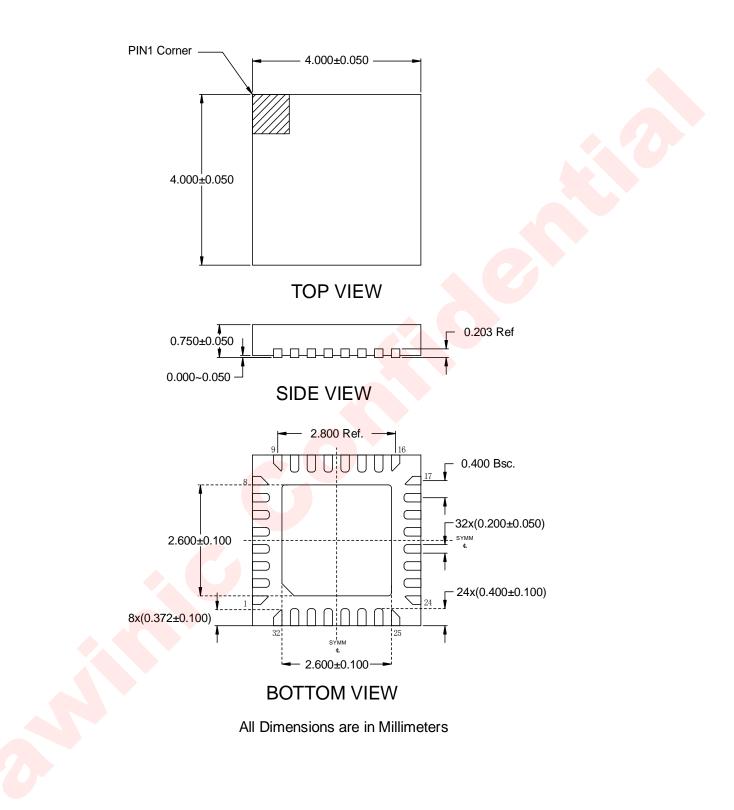
TAPE DIMENSIONS



- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole

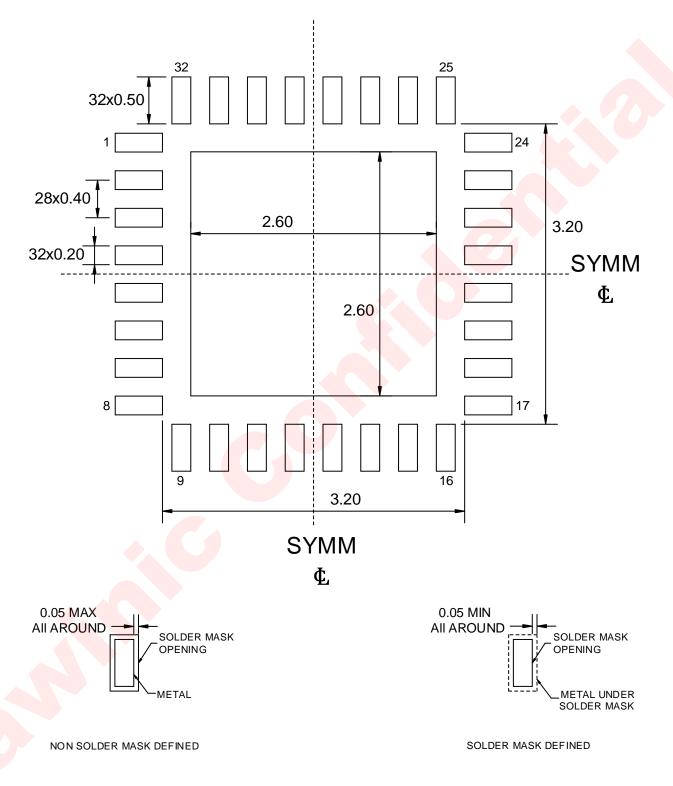
PACKAGE DESCRIPTION

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LAND PATTERN

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Dimensions are all in Millimeters

REVISION HISTORY

Version	Date	Revision Record					
V1.0	Apr. 2018	First officially release					
V1.1	Nov. 2018	Added the quiescent current in active mode	page6				
		Added the power on procedurepage9					
V1.2	Jan. 2019	Added the value of max current of each current sink with different IMAX[3:0]					
		Modify the match accuracy					
		Modify the dropout voltage for Rx	page6				
V1.3	Apr. 2019	Modify the I ² C interface descriptionpage1					
			page10				

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